L	Hits	Search Text	DB	Time stamp
Number				
1	227	HEAT ADJ CONDUCTIVE ADJ BASE	USPAT;	2003/08/08
			US-PGPUB;	15:19
		•	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
2	2	(HEAT ADJ CONDUCTIVE ADJ BASE) AND HEAT	USPAT;	2003/08/08
		ADJ INSULATING ADJ COVER	US-PGPUB;	15:20
			EPO; JPO;	
			DERWENT;	i
			IBM_TDB	
3	61	(HEAT ADJ CONDUCTIVE ADJ BASE) AND	USPAT;	2003/08/08
·		COVER	US-PGPUB;	15:23
		·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	· 33	(HEAT ADJ CONDUCTIVE ADJ BASE) AND	USPAT;	2003/08/08
		SEALED	US-PGPUB;	15:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
5	8	(HEAT ADJ CONDUCTIVE ADJ BASE) AND MATE	USPAT;	2003/08/08
			US-PGPUB;	15:26
•			EPO; JPO;	
			DERWENT;	
		·	IBM_TDB	